### 508021950 07/20/2023

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 EPAS ID: PAT8069101

Stylesheet Version v1.2

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date		
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RAMI SHARIAT-YAZDI	11/08/2016		
SHIH-LIEN LINUS LU	11/08/2016		

#### **RECEIVING PARTY DATA**

Name:	TAIWAN SEMICONDUCTOR MANUFACTURING COMPANY, LTD.
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City:	HSINCHU
State/Country:	TAIWAN
Postal Code:	300-78

#### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	18355222

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ATTORNEY DOCKET NUMBER: T5057-1191D

NAME OF SUBMITTER: RANDY A. NORANBROCK

SIGNATURE: /Randy A. Noranbrock/

DATE SIGNED: 07/20/2023

**Total Attachments: 1** 

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PATENT 508021950 REEL: 064328 FRAME: 0728

Docket No. P20150776US00 T5057-1191

## ASSIGNMENT

In consideration	on of the pren	nises and othe	er good and	l valuable	consideration	in hand	paid,	the receipt	and s	ufficiency	of
which is hereby acknow	rledged, the ur	idersigned,									

Nien-Yu TSAI
 Chin-Chang HSU
 Wen-Ju YANG

who has made a certain new and useful invention, hereby sells, assigns and transfers unto TAIWAN SEMICONDUCTOR MANUFACTURING COMPANY, LTD., having a place of business at No. 8, Li-Hsin Rd. VI, Hsinchu Science Park, Hsinchu 300, Taiwan R.O.C.

its successors and assigns (hereinafter designated "ASSIGNEE") the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100 in the invention entitled

# METHOD OF DESIGNING A SEMICONDUCTOR DEVICE, SYSTEM FOR IMPLEMENTING

THE	METHOD AND STANDARD CELL				
(a)	for which an application for United States Letters Patent was filed on	2015-12-02 ; or	, and identified by		
(b) for which an application for United States Letters Patent was executed on,					
all Unite continua Property	undersigned hereby authorizes and requests the United States Commission States Letters Patent which may be granted therefore and any and all ations-in-part thereof, and the right to all benefits under the Internation to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, and the attorneys of record in said application shall hereafter act on behalf	l extensions, divisions, reissue anal Convention for the Prot assigns and legal representative	es, continuations, or ection of Industrial		

AND the undersigned hereby agrees to transfer a like interest, and to render all necessary assistance in making application for and obtaining original, divisional, reissued or extended Letters Patent of the United States, upon request of the said ASSIGNEE, its successors, assigns and legal representatives, and without further remuneration, in and to any improvements, and applications for patent based thereon, growing out of or related to the said invention; and to execute any papers by the said ASSIGNEE, its successors, assigns and legal representatives, deemed essential to ASSIGNEE's full protection and title in and to the invention hereby transferred.

SIGNED on the date indicated aside my signature:

1) Nien-Yu Tsai	11/27/2015
Name: Nien-Yu TSAI	Date:
2) din-Chang Heu	11/27/2015
Name: Chin-Chang HSU	Date:
3)	11/27/2015
Name: Hsien-Hsin Sean LEE	Date:
4) Wen-Ju Cang	1/27/2015
Name: Wen-Ju YANG	Date:

PATENT REEL: 064328 FRAME: 0729

RECORDED: 07/20/2023